## (b) Remarks:

The claims are 16-21, with claim 16 being independent. Claim 16 has been amended to resolve an informality which is unrelated to patentability. Reconsideration of the claims is requested.

The objection to Claim 16, line 7, has been resolved by changing the phrase "the substrate" to read --a substrate--.

Claims 16-21 were rejected as obvious over Chou '580 in view of Tamayoshi '785. The Examiner admits Chou '580 fails to disclose anodizing the substrate by immersion in an anodization solution or that the substrate is of a material soluble during anodization. Tamayoshi '785 is said to disclose that which is missing in Chou. The rejection is respectfully traversed.

Prior to addressing the rejection applicants wish to briefly review certain key features and advantages of the present claimed invention. The present invention employs a patterning layer of a material soluble during anodization in which holes are formed when dissolved by the anodization solution. In the present invention, it is not necessary to remove the remaining film existing in the depression of the patterning layer by a separate step as by etching, which feature simplifies the process of hole formation. See (Example 7).

Chou'580 is devoid of any disclosure of forming holes by use of a patterning material soluble in the anodization solution. In Col. 10, Chou teaches use of

reactive ion etching or chemical etching to form recesses in the substrate. The present

invention avoids a separate etching step to form holes.

Tamayoshi merely discloses forming holes by anodization. However,

Tamayoshi fails to disclose using a patterning layer comprised of a soluble material to

reduce the steps in forming holes.

It would have not been obvious for those skilled in the art to combine Chou

having no disclosure of forming holes by anodization, but employing etching with

Tamayoshi, directed to a technique of forming holes by anodization.

Even when combined, the concept of using a patterning layer of a soluble

material to reduce the steps would be unappreciated.

The claims should be allowed and the case passed to issue.

Applicants' undersigned attorney may be reached in our New York office by

telephone at (212) 218-2100. All correspondence should continue to be directed to our

below listed address.

Respectfully submitted,

/Peter\_Saxon/

Peter Saxon

Attorney for Applicants

Registration No. 24,947)

FITZPATRICK, CELLA, HARPER & SCINTO

30 Rockefeller Plaza

New York, New York 10112-3801

Facsimile: (212) 218-2200

FCHS WS 2065700v1

5